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		SPE Date	C.No. ASDIQ-SPE-86(00) 9: Jul.13,2022
То :			
	CUSTOMER'S PRC		
	ASDI PRODUCT N/ SPAC73N-SERIE		
RECEIPT CONFIRMATION			
UNCONDITIONA	CONSENT	CONDI	FIONAL CONSENT
APP	PROVED	CHE	CKED
ASDI SIGNATURE			
APPROVED	CHECKED	PREPARED	
Xianglong Li	Liang Wang	Jiayin Cai	



Xiamen ASDI Electronics Co.,Ltd.

REV.	DATE	DESCRIPTION	APPROVED	CHECKED	PREPARED
00	Jul.13,2022	New release	Xianglong Li	Liang Wang	Jiayin Cai

# **CAUTION WHEN HANDLING**

Before use the products, please read this specification.

## **CAUTION FOR SAFETY USING**

When use the products, be careful to mentioned below for safety using.

## CAUTION \*The product should be used within 12 monthes. Focus on the storage conditions. Solderability may become weak if it exceeds the period. \*Do not use and store the product in condition of gas corrosion (Salt,Acid,Alkaline). \*The products must be preheated before soldering. The operating temperature including self-generated heat must be within '-40~+125°C \*Rework by soldering iron; Please keep the mentioned conditions in this specification. \*In case of insert P.C. Board on chassis, do not add mechanical stress to the product. \*Be careful to arrange of non-magnetic field type inductors. The error may be caused by magnetic field coupling. \*In case handle the products, please use wrist strap for ground static discharge on human body. The product keeps away from magnet or magnetized things. \*Do not use the product beyond the mentioned conditions in this specification. \*About an application The products listed on this specification sheet are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition. \*The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet. 1)Aerospace/Aviation equipment 6)Transportation control equipment 2)Military equipment 7)Power-generation control equipment 3)Seabed equipment which directly endanger human life 4)Safety equipment 8)Atomic energy-related equipment 5)Medical equipment 9)Other applications that are not considered general-purpose applications If you intend to use the products in the following applications, please contact our sales office. Transportation equipment (cars, electric trains, ships, etc.), Public information-processing equipment. Electric heating apparatus / burning equipment. Disaster prevention/crime prevention equipment When using this product in general-purpose applications, you are kindly requested to take into consideration securing protection circuit/equipment or providing backup circuits, etc., to ensure higher safety. DWG.No. Xiamen ASDI Electronics Co.,Ltd. ISSUE ASDIQ-SPE-86(00)

CUSTOMER	ASDI PART No.	CUSTOMER'S DWG NO.
Each Corporation	SPAC73N-SERIES	

1.SCOPE

Power source inductor for mobile devices such as HDDs, DVCs,DSCs,mobile display panels, portable game devices, compact power supply LCDs, other DC to DC converters

2.INDEX

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## 3.Manufacturing Location

China

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#### (1)Features

This specification applies Low Profile Power Inductors. 100% Lead(Pb) & Halogen-Free and RoHS compliant.

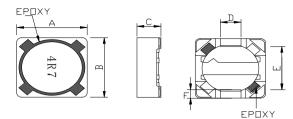


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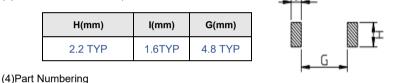
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### (2)Dimensions



Series	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)	F(mm)
SPAC73N	7.3±0.5	7.3±0.5	3.4MAX	2.0TYP	5.0TYP	1.1TYP

(3)Recommendend Land pattern



4R7=4.7µH

M=±20%; N=±30%

SPAC 73 Ν 4R7 с А в

A: Series

**B:** Dimension

C: Control S/N

D: Inductance

E: Inductance Tolerance

### (5)Electrical Specification

Table 1 Inductance Tolerance DCR l sat l rms **ASDI Part Number Test Frequency** (Ω) Max (µH) (%) (A) (A) SPAC73N-1R0N 1.00 ±30% 100kHz/0.25 0.210 4.21 4.00 SPAC73N-1R5N 1.50 ±30% 100kHz/0.25 0.240 3.98 3.75 2.20 0.280 SPAC73N-2R2N ±30% 100kHz/0.25 3.72 3.50 0.280 SPAC73N-3R3N 3.30 ±30% 100kHz/0.25 3.64 3.30 SPAC73N-4R7N 4.70 ±30% 100kHz/0.25 0.035 3.20 2.56 SPAC73N-6R8N 6.80 ±30% 100kHz/0.25 0.070 1.80 1.44 100kHz/0.25 SPAC73N-100M 10.0 ±20% 0.080 1.50 1.20 SPAC73N-150M 15.0 ±20% 100kHz/0.25 0.180 1.30 1.04 SPAC73N-220M 22.0 100kHz/0.25 0.200 1.10 0.88 ±20% 0.80 SPAC73N-330M 33.0 ±20% 100kHz/0.25 0.340 1.00 0.48 SPAC73N-470M 47.0 ±20% 100kHz/0.25 0.380 0.60 SPAC73N-680M 68.0 ±20% 100kHz/0.25 0.540 0.50 0.40 SPAC73N-101M 100.0 ±20% 100kHz/0.25 0.820 0.35 0.28

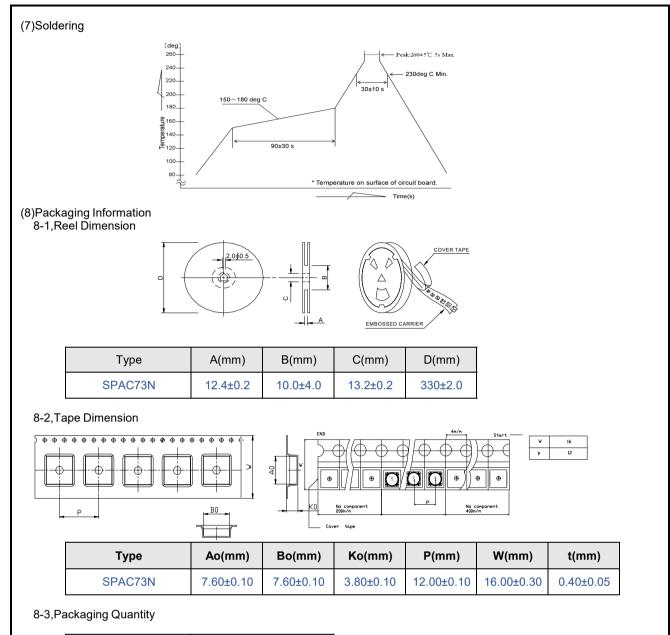
Note:

Isat: Based on inductance change ( $\triangle$ L/L0:  $\leq$ -35%) @ ambient temp. 25°C Irms: Based on temperature rise (△T: 40°C typ.)

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No.	Test item	Performance	Test details
1	Operating temperature	- 40 ~ +125℃	Including self-generated heat
2	Storage temperature	$-40 \sim +85^{\circ}$ C. - 5 to 40°C for the product with taping.	
3	Rated current		
4	Inductance (L)		LCR Meter: HP 4285A or equivalent, 100kHz, 0.25V
5	DC Resistance	Within the specified tolerance	DC Ohmmeter: HIOKI3227 or equivalent
6	Temperature characteristics	Inductance change: Within±20%	Measurement of inductance shall be taken at temperature rang within-40°C to +85°C. With reference to inductance value at+20°C, change rate shall be calculated. Measurement of inductance shall be taken at temperature rang within-40°C to +125°C. With reference to inductance value at+20°C, change rate shall be calculated.
7	Resistance to flexure substrate	No damage	The test samples shall be soldered to the testing board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2mm. Force Road R5 Board R5 Board R5 Board R5 Board R5 Board R5 Board Test Sample Substrate size: 100x40x1.0 Substrate material: glass epoxy-resin Solder cream thickness: 0.15 4.0
8	Adhesion of Terminal electrode	Shall not come off PC board.	The test samples shall be soldered to the testing board and by the reflow. Image: 10 N, 5 s Applied force: 10 N to X and Y directions. Duration: 5s
9	Resistance to Vibration	Inductance change: Within±10% No abnormality observed in appearance.	Solder cream thickness: 0.15 The test samples shall be soldered to the test board by the reflow. Then it shall be submitted to below test conditions. Frequency: 10-55Hz Total Amplitude: 1.5mm (May not exceed acceleration 196m/S2 ) Sweeping Method:10Hz to 55Hz to 10Hz for 1min. Time: 2 hours each in X,Y, and Z Direction. Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.
10	Solderability	At least 90% of surface of terminal electrode is covered by new solder.	The test samples shall be dipped in flux, and then immersed in molten solder as shown in below. Flux: methanol solution containing rosin 25% Solder temperature: 245±5℃ Time: 5±1.0 sec. Immersion depth: All sides of mounting terminal shall be immersed.
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No.	Test item	Performance		Test detai	ils	
11	Resistance to soldering		℃ for 40 seco 5 seconds,2 ti Test board thi	le shall be exposed nds, with peak tem mes. ckness: 1.0mm aterial: glass epoxy-	perature at 260	
12	Thermal shock		The test samp the reflow. The test samp for specified ti sequence. The temperatu	les shall be soldere les shall be placed me by step 1 to ste ire cycles shall be i	ed to the test bo l at specified ter op 4 as shown b repeated 100 c	nperat elow ir
			Phase 1 2 3	Temperature(°C) -40±3°C Room Temp 85±2°C	Time(min.) 30±3 Within 3 30±3	
			4	Room Temp	Within 3	
13	Damp heat life test	Inductance change: Within±10% No abnormality observed in appearance.	soldered to the The test samp	95%RH	reflow. I in thermostatic	oven
14	Loading under damp heat life test		The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven s at specified temperature and humidity and applied the rated current continuously as shown in below. Temperature: 60±2°C Humidity: 90~95%RH Applied current: Rated current Time: 500+24/-0 hrs			
15	Low temperature life test		the reflow. After that, the			
16	Loading at high temperature life test		The test samp the reflow. Temperature:	les shall be soldere 85±2℃. It: Rated current	ed to the test bo	oard by



Туре	Chip / Reel	
SPAC73N	1000	

(9)Note

·Storage Conditions

To maintain the solderability of terminal electrodes:

- 1. ASDI products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 2. Temperature and humidity conditions: Temperature: 5 to 30deg.C, Humidity: 75% Max.
- 3. Recommended products should be used within 12 months form the time of delivery.

4. The packaging material should be kept where no chlorine or sulfur exists in the air.

- ·Transportation
- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

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